

MOS FIELD EFFECT TRANSISTOR

NP32N055HLE, NP32N055ILE

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance

RDS(on)1 = 26 m Ω MAX. (VGS = 10 V, ID = 16 A)

RDS(on)2 = 35 m Ω MAX. (VGS = 5 V, ID = 16 A)

- Low Ciss: Ciss = 1090 pF TYP.
- Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
NP32N055HLE	TO-251
NP32N055ILE	TO-252

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	Voss	55	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID(DC)	±32	Α
Drain Current (Pulse) Note1	D(pulse)	±128	Α
Total Power Dissipation (T _A = 25°C)	Рт	1.2	W
Total Power Dissipation (Tch = 25°C)	\mathbf{P}_{T}	40	W
Single Avalanche Current	I AS	T.B.D.	Α
Single Avalanche Energy Note2	Eas	T.B.D.	mJ
Channel Temperature	Tch	175	°C
Storage Temperature	T_{stg}	-55 to +175	°C

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1 %

2. Starting T_{ch} = 25°C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 V

THERMAL RESISTANCE

Channel to Case	Rth(ch-c)	3.75	°C/W	
Channel to Ambient	Rth(ch-a)	125	°C/W	

The information contained in this document is being issued in advance of the production cycle for the device. The parameters for the device may change before final production or NEC Corporation, at its own discretion, may withdraw the device prior to its production.

Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.



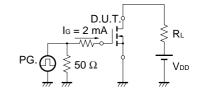
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 16 A		20.8	26	mΩ
	RDS(on)2	Vgs = 5 V, ID = 16 A		25	35	mΩ
	RDS(on)3	Vgs = 4.5 V, ID = 16 A		26	36	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	$V_{DS} = 10 \text{ V}, I_{D} = 250 \mu\text{A}$	1.5	2	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 16 A	7	13		S
Drain Leakage Current	Ipss	V _{DS} = 55 V, V _{GS} = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		1090	1640	pF
Output Capacitance	Coss			240	360	pF
Reverse Transfer Capacitance	Crss			99	180	pF
Turn-on Delay Time	td(on)	$I_D = 16 A, V_{GS(on)} = 10 V, V_{DD} = 28 V,$		40	88	ns
Rise Time	t r	$R_G = 10 \Omega$		190	480	ns
Turn-off Delay Time	td(off)			63	130	ns
Fall Time	t f			120	300	ns
Total Gate Charge 1	Q _{G1}	ID = 32 A, VDD = 44 V, VGS = 10 V		21	32	nC
Total Gate Charge 2	Q _{G2}	ID = 32 A, VDD = 44 V, VGS = 5 V		15	23	nC
Gate to Source Charge	Qgs			3		nC
Gate to Drain Charge	Q _{GD}			6		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 32 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 32 A, VGS = 0 V, $di/dt = 100A/\mu S$		49		ns
Reverse Recovery Charge	Qrr			100		nC

TEST CIRCUIT 1 SWITCHING TIME

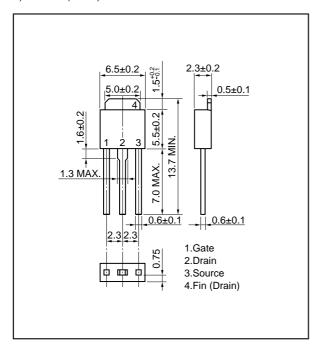
Vgs **≷** R∟ 90% Vgs 0 10% VGS(on R_G R_G = 10 Ω V_{DD} ΙD 90% 90% ID Vgs 0 10% 10% 0 τ $τ = 1 \mu s$ Duty Cycle $\le 1 \%$

TEST CIRCUIT 2 GATE CHARGE

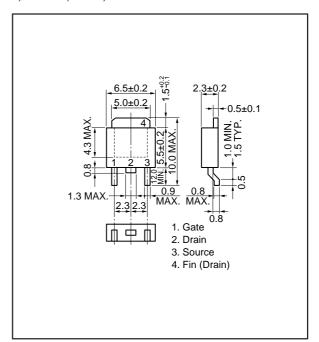


PACKAGE DRAWINGS (Unit: mm)

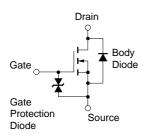
1) TO-251 (MP-3)



2) TO-252 (MP-3Z)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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